



## Specifications

Mounting Style:	Panel-type
Permissible Temp. With / Without load:	0 to 85 deg. C
Permissible Temp. For Soldering:	270 deg. C for 5 seconds max.
Panel Thickness(Max):	na
Material:	Nylon
Insulation Resistance:	1000 M Ohms min.
H. V. Break Down:	2 KV AC for 1 minute
Current Carrying Parts:	Copper, Tin plated
Contact Resistance (Initial):	10 m ohms max.
Cap Design:	Coin-slot
Fuse Link Size:	6.3 x 32
Rated Current / Voltage:	30A DC, 250 V
Terminals:	Solder-type



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